

## Proposed Document Structure

1. Introduction
2. Mechanical Specifications
  - 2.1 Form Factor
    - 2.1.1 Retention Mechanism
  - 2.2 Cooling Considerations
  - 2.3 EMC Considerations
  - 2.4 Connector Specification
    - 2.4.1 Device Connector
    - 2.4.2 Enclosure Connector
    - 2.4.3 Contact Assignments
3. Electrical Specification
  - 3.1 Device Power
  - 3.2 Power Management
4. Hot Plugging
5. Enclosure Services
  - 5.1 SES support
  - 5.2 Device Indicator Lights
6. Software Considerations
  - 6.1 Booting
  - 6.2 Device IDs (physical vs. SCAM)

Annexes?